



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Lua et al.

Serial No.: 10/634,123

Filed: August 4, 2003

For: SEMICONDUCTOR SUBSTRATES
INCLUDING I/O REDISTRIBUTION
USING WIRE BONDS AND ANISOTROPICALLY CONDUCTIVE FILM,
METHODS OF FABRICATION AND
ASSEMBLIES INCLUDING SAME

Examiner: Unknown

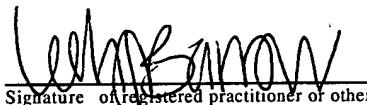
Group Art Unit: Unknown

Attorney Docket No.: 5709US (02-1462.00/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

September 18, 2003
Date of Deposit


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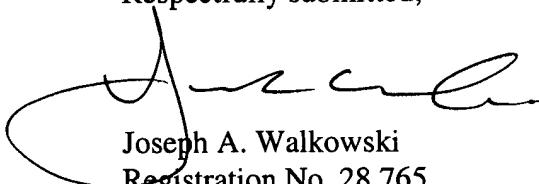
COMMUNICATION

Commissioner for Patents
Washington, D.C. 20231

Sir:

Enclosed is a certified copy of priority document 200303830-4 filed July 22, 2003 concerning the above-referenced application.

Respectfully submitted,



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Date: September 18, 2003